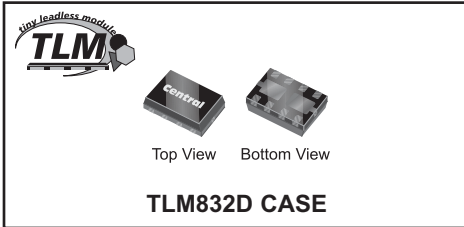


CTLDM7120-M832D

**SURFACE MOUNT
DUAL, N-CHANNEL
ENHANCEMENT-MODE
SILICON MOSFETS**



www.centrasemi.com



• Device is **Halogen Free** by design

APPLICATIONS:

- Switching Circuits
- DC - DC Converters
- Battery powered portable devices

MAXIMUM RATINGS: (T_A=25°C)

Drain-Source Voltage
Gate-Source Voltage
Continuous Drain Current (Steady State)
Maximum Pulsed Drain Current, tp=10µs
Power Dissipation (Note 1)
Operating and Storage Junction Temperature
Thermal Resistance (Note 1)

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CTLDM7120-M832D is an Enhancement-mode Dual N-Channel Field Effect Transistor, manufactured by the N-Channel DMOS Process, designed for high speed pulsed amplifier and driver applications. This MOSFET offers Low r_{DS(ON)} and Low Threshold Voltage.

MARKING CODE: CFT

FEATURES:

- ESD protection up to 2kV
- Low r_{DS(ON)} (0.25Ω MAX @ V_{GS}=1.5V)
- High current (I_D=1.0A)
- Logic level compatibility

SYMBOL		UNITS
V _{DS}	20	V
V _{GS}	8.0	V
I _D	1.0	A
I _{DM}	4.0	A
P _D	1.65	W
T _J , T _{stg}	-65 to +150	°C
θ _{JA}	76	°C/W

ELECTRICAL CHARACTERISTICS PER TRANSISTOR: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _{GSSF} , I _{GSSR}	V _{GS} =8.0V, V _{DS} =0			10	µA
I _{DSS}	V _{DS} =20V, V _{GS} =0			10	µA
BV _{DSS}	V _{GS} =0, I _D =250µA	20			V
V _{GS(th)}	V _{DS} =10V, I _D =1.0mA	0.5		1.2	V
V _{SD}	V _{GS} =0, I _S =1.0A			1.1	V
r _{DS(ON)}	V _{GS} =4.5V, I _D =500mA		0.075	0.10	Ω
r _{DS(ON)}	V _{GS} =2.5V, I _D =500mA		0.10	0.14	Ω
r _{DS(ON)}	V _{GS} =1.5V, I _D =100mA		0.17	0.25	Ω
Q _{g(tot)}	V _{DS} =10V, V _{GS} =4.5V, I _D =1.0A		2.4		nC
Q _{gs}	V _{DS} =10V, V _{GS} =4.5V, I _D =1.0A		0.25		nC
Q _{gd}	V _{DS} =10V, V _{GS} =4.5V, I _D =1.0A		0.65		nC
g _{FS}	V _{DS} =10V, I _D =500mA		4.2		S
C _{rss}	V _{DS} =10V, V _{GS} =0, f=1.0MHz		45		pF
C _{i,ss}	V _{DS} =10V, V _{GS} =0, f=1.0MHz		220		pF
C _{oss}	V _{DS} =10V, V _{GS} =0, f=1.0MHz		120		pF
t _{on}	V _{DD} =10V, V _{GS} =5.0V, I _D =500mA		25		ns
t _{off}	V _{DD} =10V, V _{GS} =5.0V, I _D =500mA		140		ns

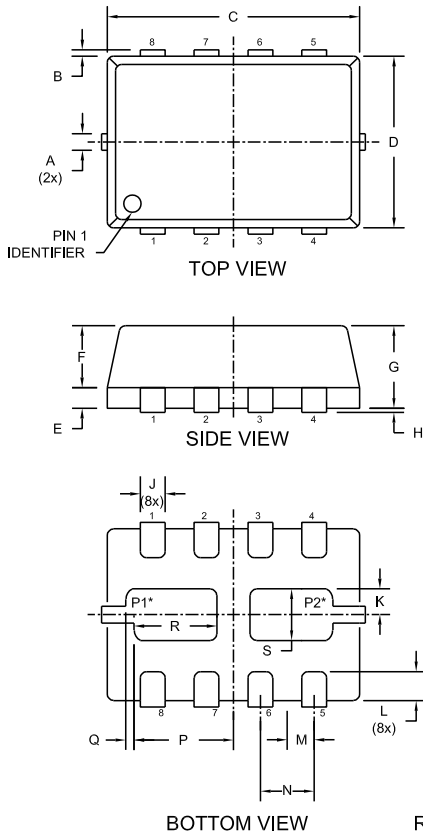
Notes: (1) FR-4 Epoxy PCB with copper mounting pad area of 54mm².

R2 (2-August 2011)

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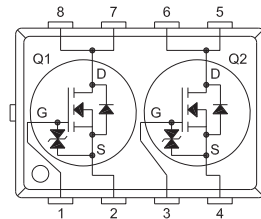
TLM832D CASE - MECHANICAL OUTLINE



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.007	0.012	0.170	0.300
B	-	0.005	-	0.125
C	0.114	0.122	2.900	3.100
D	0.075	0.083	1.900	2.100
E	0.006	0.010	0.150	0.250
F	0.026	0.030	0.650	0.750
G	0.031	0.039	0.800	1.000
H	0.000	0.002	0.000	0.050
J	0.009	0.013	0.240	0.340
K	0.006	0.014	0.160	0.360
L	0.008	0.018	0.200	0.450
M	0.013		0.325	
N	0.026		0.650	
P	0.040	0.048	1.010	1.210
Q	0.004		0.100	
R	0.032	0.040	0.820	1.020
S	0.017	0.025	0.430	0.630

TLM832D (REV: R2)

PIN CONFIGURATION



LEAD CODE:

- 1) Gate Q1
- 2) Source Q1
- 3) Gate Q2
- 4) Source Q2
- 5) Drain Q2
- 6) Drain Q2
- 7) Drain Q1
- 8) Drain Q1

MARKING CODE: CFT

*** Note:**

- Exposed pad P1 common to pins 7 and 8
- Exposed pad P2 common to pins 5 and 6

R2 (2-August 2011)